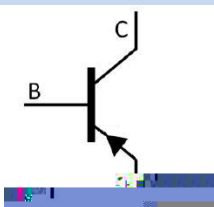


## / Descriptions

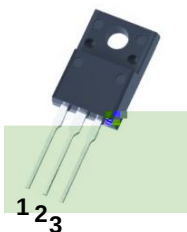
## / Features

## / Applications

## / Equivalent Circuit



## / Pinning

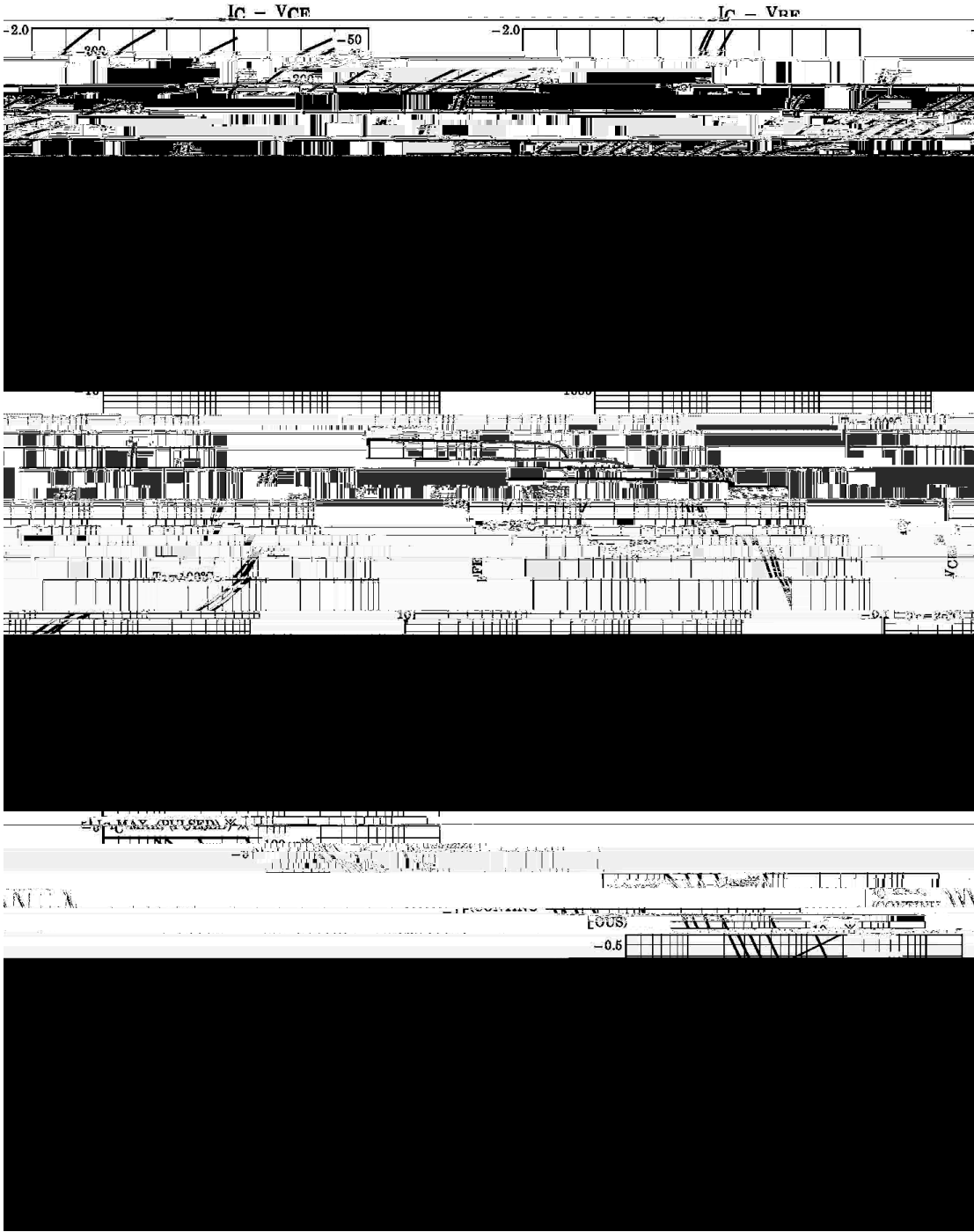


## / $h_{FE}$ Classifications & Marking

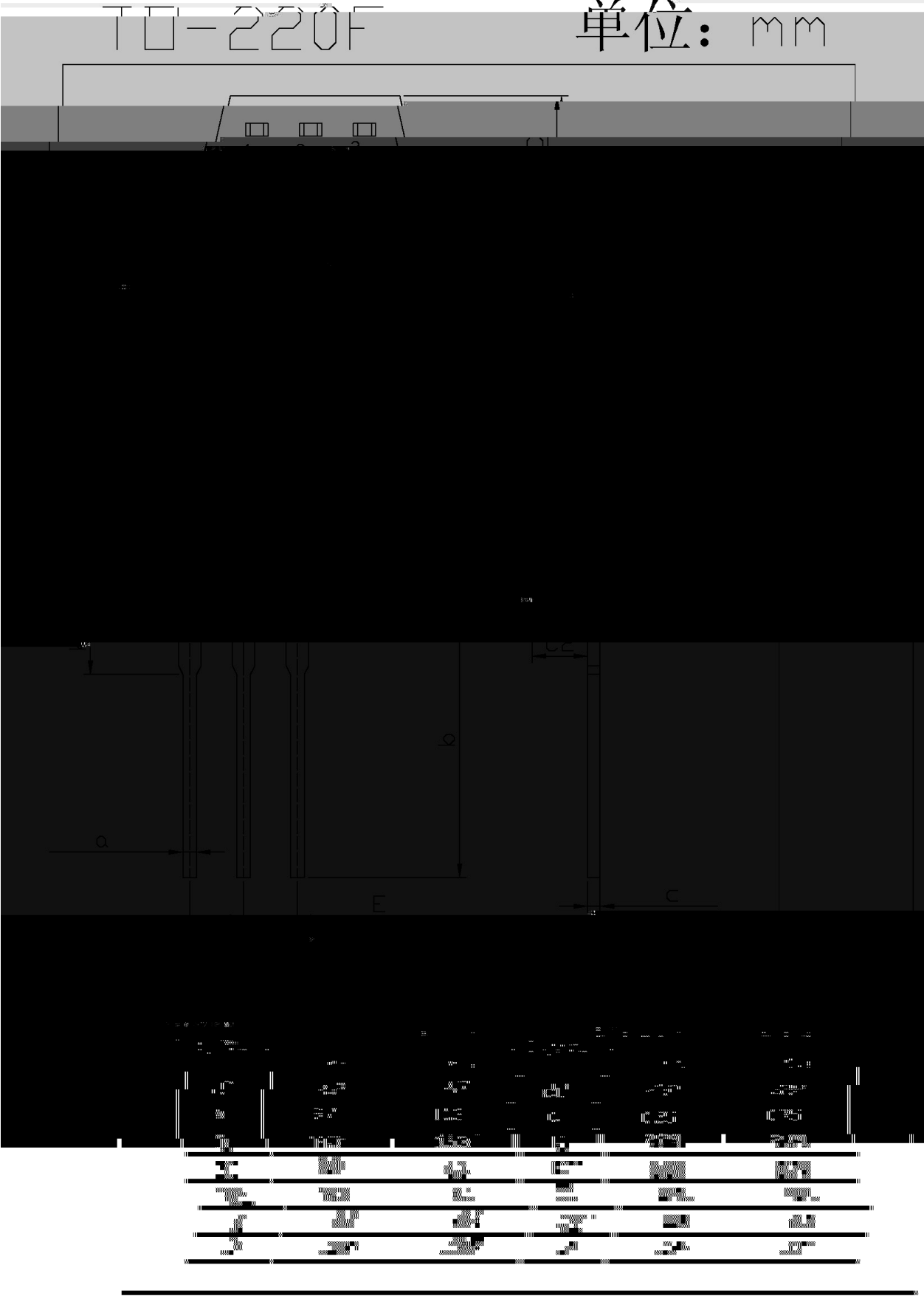
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/ Electrical Characteristic Curve



/ Package Dimensions





(     ) / Temperature Profile for Dip Soldering(Pb-Free)



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